I²C Bus I/O Expander

The JLC1562B facilitates easy I²C Bus expandibility. Multiple devices (up to 8 on the same I²C Bus) are easily added as each device has its own selectable 3-bit address. The JLC1562B provides an 8-bit bidirectional input/output port and 6-bit resolution Digital to Analog Converter. The voltage on pins P0-P4 is compared with a controllable threshold voltage and the results are readable through the I²C Bus.

I²C Bus interface pins SDA, SCL and A0–A2 are; Serial Data, Serial Clock and Device Address respectively. External interface pins are P0–P7 and VDAC; I/O Port and D/A output.

Features

- Pb-Free Packages are Available*
- Low Power Dissipation
- I²C-Bus Format (2-Wire Type; SDA, SCL) Data Transfer
- 6-bit DAC
- Bus Address Selectable (3-bit)
- Address Input Pins are Pulled Up to V_{DD} with Internal Resistor
- I/O Pins are Open Drain Outputs
- 5 Comparators at Inputs
- Inputs Protected from External Bus Currents in Power Down Mode

A0 [1 ●	16] V _{DD}
A1 [2	15] SDA
A2 [3	14] SCL
P0 [4	13] VDAC
P1 [5	12] P7
P2 [6	11] P6
P3 [7	10] P5
V _{SS} [8	9] P4

Figure 1. Pin Assignment

PIN LIST					
A0-A2	Chip Address Input				
P0-P4	Comparator Input / Open Drain Output				
P5-P7	Comparator Input / Open Drain Output				
SCL	Serial Clock Input				
SDA	I ² C Data Output				
VDAC	DAC Output				



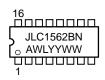
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MARKING DIAGRAMS



PDIP-16 N SUFFIX CASE 648





EIAJ-16 F SUFFIX CASE 966



A = Assembly Location

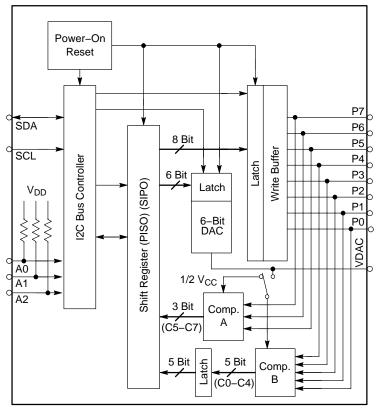
WL, L = Wafer Lot YY, Y = Year WW, W = Work Week

ORDERING INFORMATION

Device	Package	Shipping [†]
JLC1562BN	PDIP-16	500 / Unit PAK
JLC1562BNG	PDIP-16 (Pb-Free)	500 / Unit PAK
JLC1562BF	EIAJ-16 (Pb-Free)	50 Units / Rail
JLC1562BFEL	EIAJ-16 (Pb-Free)	2000 Units / Reel

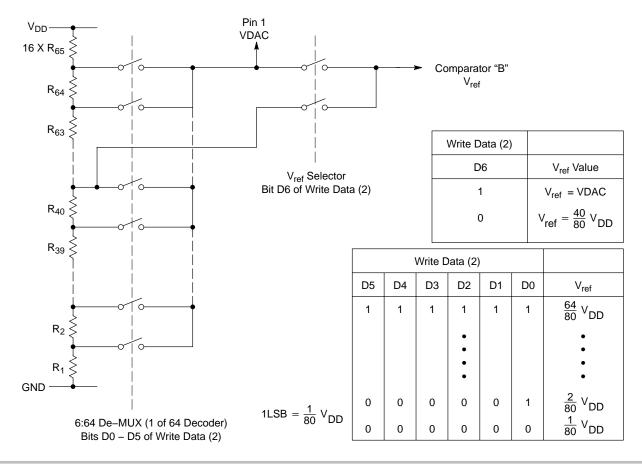
[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

^{*}For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.



NOTE: Internal Power On Reset sets P0 \sim P7 low, sets VDAC to 1/80 $\rm V_{DD}$ and selects 1/2 $\rm V_{DD}$ for Comparator "B" threshold.

Figure 2. Block Diagram



MAXIMUM RATINGS (Referenced to GND)

Symbol	Parameter	Value	Unit
V _{dd}	DC Supply Voltage	-0.5 to +7.0	V
V _{in}	DC Input Voltage	–0.5 to V _{dd} +0.5	V
V _{out}	DC Output Voltage	–0.5 to V _{dd} +0.5	V
I	DC Input/Output Current (per Pin)	25	mA
I _{DD}	DC Supply Current (V _{DD} and GND Pins)	75	mA
T _{stg}	Storage Temperature Range	-65 to +150	°C
TL	Lead Temperature, 1 mm from Case for 10 Seconds	300	°C

Maximum ratings are those values beyond which device damage can occur. Maximum ratings applied to the device are individual stress limit values (not normal operating conditions) and are not valid simultaneously. If these limits are exceeded, device functional operation is not implied, damage may occur and reliability may be affected.

RECOMMENDED OPERATING CONDITIONS

Symbol	Parameter	Min	Max	Unit
V_{dd}	DC Supply Voltage	4.2	6.0	V
V _{in} , V _{out}	DC Input Voltage	0.0	V_{dd}	V
T _A	Operating Temperature	-40	+85	°C

DC CHARACTERISTICS (Referenced to V_{ss})

		Guarante	Guaranteed Limit		
Symbol	Parameter	Min	Max	Unit	
V _{IH}	Maximum Input Voltage, "H"	0.7 V _{dd}	-	V	
V _{IL}	Maximum Input Voltage, "L"	-	0.3 V _{dd}	V	
V _{OL}	Maximum Output Voltage, "L" (I _{out} = 4mA)	-	0.3	V	
l _{in}	Maximum Input Leakage Current (V _{in} = V _{dd} or V _{ss} , SCL pin only)	-	± 1.0	μΑ	
l _{oz}	Maximum Output Hi–Z Leakage Current (Output = High Impedance; Vout = Vdd)	-	± 5.0	μΑ	
C _{in}	Maximum Input Capacitance (Input Pin)	-	10	pF	
C _{out}	Maximum Output Capacitance (Output Pin)	-	15	pF	
C _{i/o}	Maximum I/O Capacitance (I/O Pin)	-	15	pF	
V _{ICR}	Comparator Common Mode Input Voltage Range	0	V _{dd} –1.5	V	
I _{CC}	Maximum Quiescent Supply Current (per Package)	-	5.0	mA	

COMPARATOR AC CHARACTERISTICS

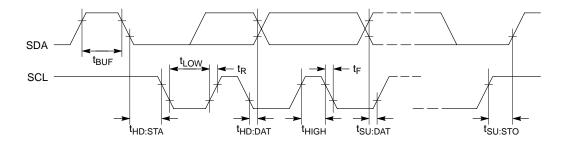
			Guaranteed Limit			
Symbol	Parameter	Test Conditions	Min	Тур	Max	Unit
t _{PD}	Maximum Propagation Delay	V _{ref} = 1.5 V, 10mV overdrive	_	1.0	_	μS
		V _{ref} = 1.5 V, 100mV overdrive	_	0.2	_	μS

DA COMPARATOR CHARACTERISTICS

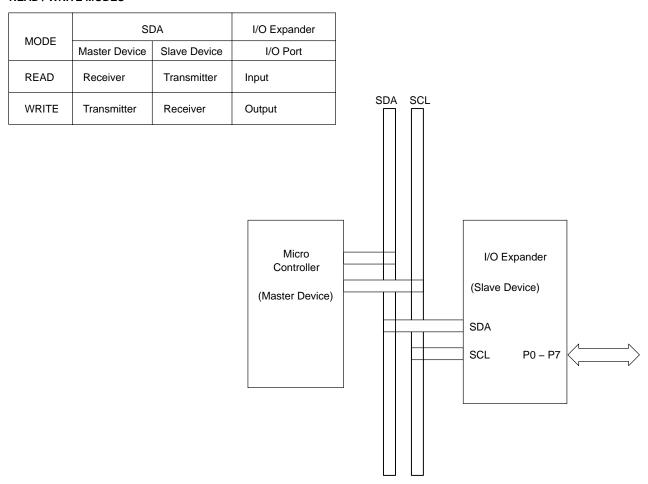
		Guaranteed Limit			
Symbol	Parameter	Min	Тур	Max	Unit
DNL	DAC Referential NON-Linearity		±1/4 LSB		
e _{FS}	DAC Full Scale Error			±1 LSB	
e _{ZC}	DAC Zero Scale Error			±1 LSB	

TIMING CHARACTERISTICS

		Guaranteed Limit		
Symbol	Symbol Parameter		Max	Unit
f _{CL}	SCL CLOCK Frequency	0	100	kHz
t _{BUF}	BUS Free Time (Between "STOP" and "START")	4.7	-	μs
t _{HD:STA}	HOLD Time for "START"	4.0	-	μs
t_{LOW}	HOLD Time at SCL CLOCK LOW	4.7	-	μs
tHIGH	HOLD Time at SCL CLOCK HI	4.0	-	μs
t _{HD:DAT}	DATA HOLD Time	0	-	μS
t _{SU:DAT}	DATA SETUP Time	250	-	ns
t _R	Rise Time (SDA and SCL)	-	1000	ns
t _F	Fall Time (SDA and SCL)	-	300	ns
t _{SU:STO}	SETUP Time for "STOP"	4.0	-	μs



READ / WRITE MODES



The JLC1562B Supports the following types of Bus Cycles

1.) WRITE MODE (A)

S	Slave Address & R/W	SACK	Write Data (1)	SACK	Р	
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2.) WRITE MODE (B)

s	Slave Address & R/W	SACK	Write Data (1)	SACK	Write Data (2)	SACK	Р	

3.) READ MODE (A)

S	Slave Address & R/W	SACK	Read Data	MACK	Р	
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4.) READ MODE (B)

S	Slave Address & R/W	SACK	Read Data (1)	MACK	Read Data (2)	MACK	Read Data (3)	MACK	•••	Р	

S = START Condition

SACK = Slave Acknowledgement

MACK = Master Acknowledgement

P = STOP Condition

READ WRITE DATA FORMAT



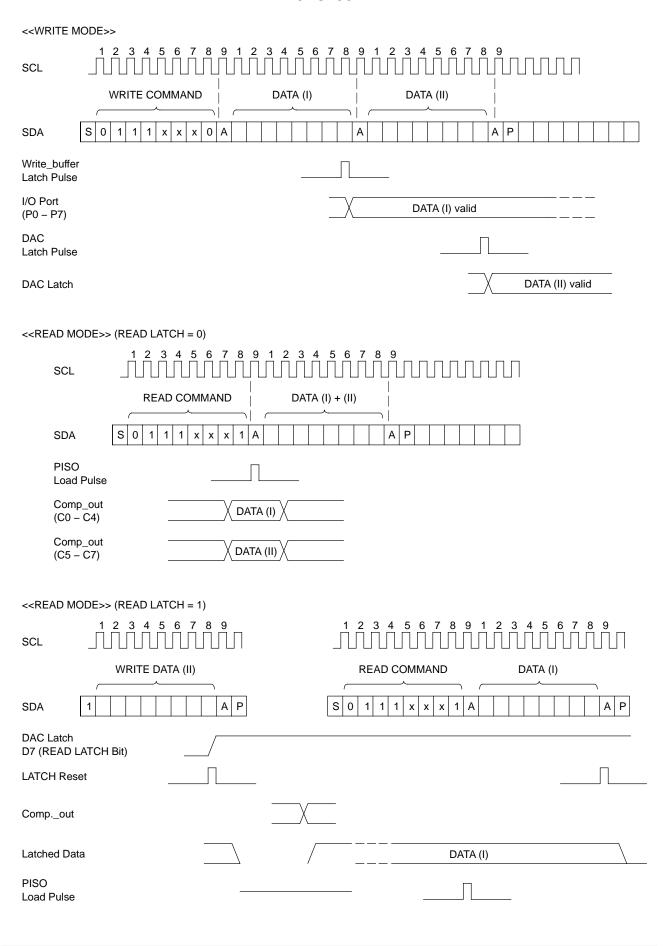


Slave Address	A0 – A2	I/O Expander Device Address (Pins A0 – A2)
	A3 – A6	A6 A5 A4 A3 is hard wired as 0 1 1 1
	R/W	1 : READ ADDRESS
Read Data	D5 – D7	Output of Comparator "A". (V _{th} = 1/2 V _{DD})
	D0 – D4	Output of Comparator "B". (V_{th} = 1/2 V_{DD} OR V_{DAC}) READ LATCH Bit Controls when Data Will Be Latched.

<<WRITE MODE>>

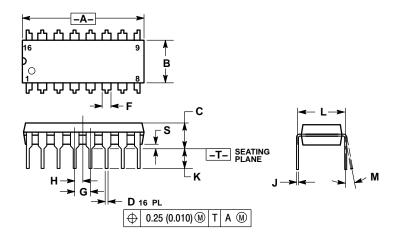


Slave Address	A0 – A2	I/O Expander Device Address (Pins A0 – A2)
	A3 – A6	A6 A5 A4 A3 is hard wired as 0 1 1 1
	R/W	0 : WRITE ADDRESS
Write Data (1)	D0 – D7	Device Pins P0 to P7 Output Bits.
Write Data (2)	D7	READ LATCH CONTROL Latch Control of Signals C0 – C4 in the Device BLOCK DIAGRAM
		Data is latched at the ACK after a READ COMMAND. Data is latched when Comparator "B" switches from 0 to 1. (switch point is controlled by V _{th} .) Data is reset at the ACK after a READ COMMAND.
	D6	COMPARATOR "B" V _{ref} Control Bit
		$0: V_{ref} = \frac{40}{80} V_{DD}$
		$1: V_{ref} = V_{DAC}$
	D0 – D5	DAC Input Bits



PACKAGE DIMENSIONS

PDIP-16 **N SUFFIX** CASE 648-08 ISSUE T

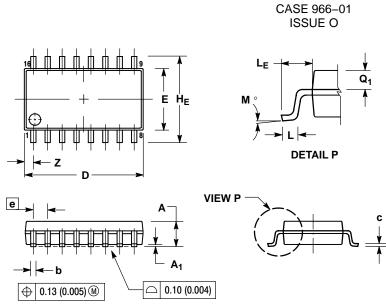


- NOTES:
 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 2. CONTROLLING DIMENSION: INCH.
 3. DIMENSION L TO CENTER OF LEADS WHEN FORMED PARALLEL.
 4. DIMENSION B DOES NOT INCLUDE MOLD FLASH.
 5. ROUNDED CORNERS OPTIONAL.

	INC	HES	MILLIMETERS			
DIM	MIN	MAX	MIN	MAX		
Α	0.740	0.770	18.80	19.55		
В	0.250	0.270	6.35	6.85		
С	0.145	0.175	3.69	4.44		
D	0.015	0.021	0.39	0.53		
F	0.040	0.70	1.02	1.77		
G	0.100	BSC	2.54	BSC		
Н	0.050	BSC	1.27	BSC		
J	0.008	0.015	0.21	0.38		
K	0.110	0.130	2.80	3.30		
L	0.295	0.305	7.50	7.74		
M	0°	10 °	0°	10 °		
S	0.020	0.040	0.51	1.01		

PACKAGE DIMENSIONS

EIAJ-16 **F SUFFIX**



NOTES:

- NOTES:

 1. DIMENSIONING AND TOLERANCING PER ANSI Y14,5M, 1982.

 2. CONTROLLING DIMENSION: MILLIMETER.

 3. DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH OR POTTRUSIONS AND ARE MEASURED AT THE PARTING LINE. MOLD FLASH OR PROTRUSIONS SHALL NOT EXCEED 0.15 (0.006) PER SIDE.

 4. TERMINAL NUMBERS ARE SHOWN FOR REFERENCE ONLY.

 5. THE LEAD WIDTH DIMENSION (b) DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.08 (0.003) TOTAL IN EXCESS OF THE LEAD WIDTH DIMENSION AT MAXIMUM MATERIAL CONDITION. DAMBAR CANNOT BE LOCATED ON THE LOWER RADIUS OR THE FOOT. MINIMUM SPACE BETWEEN PROTRUSIONS AND ADJACENT LEAD TO BE 0.46 (0.018). TO BE 0.46 (0.018).

	MILLIN	IETERS	INCHES		
DIM	MIN	MAX	MIN	MAX	
Α	-	2.05		0.081	
A ₁	0.05	0.20	0.002	0.008	
b	0.35	0.50	0.014	0.020	
С	0.18	0.27	0.007	0.011	
D	9.90	10.50	0.390	0.413	
Е	5.10	5.45	0.201	0.215	
е	1.27	BSC	0.050 BSC		
HE	7.40	8.20	0.291	0.323	
L	0.50	0.85	0.020	0.033	
LE	1.10	1.50	0.043	0.059	
M	0 °	10 °	0 °	10°	
Q ₁	0.70	0.90	0.028	0.035	
Z		0.78		0.031	

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